Changwoo Lee

Curriculum Vitae

CONTACT INFORMATION

1301 Beal Avenue, Ann Arbor, MI, 48109, USA

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Website: https://changwoolee.github.io/

EDUCATION

University of Michigan, Ann Arbor, Michigan, USA

■ Ph.D. in Electrical and Computer Engineering

Aug 2020 - Present

Adviser: Prof. Hun-Seok KimAnticipated Graduation Year: 2025

Hanyang University, Seoul, Republic of Korea

• M.S. in Electronics and Computer Engineering

Mar 2018 – Feb 2020

■ B.S. in Electronic Engineering

Mar 2012 - Feb 2018

RESEARCH INTERESTS

Efficiency and Robustness in Deep Learning

- Efficient DNN Structure for Low Computational Complexity and Memory Footprint
 - •Resource-efficient and Expressive Structured Matrix for Fast Matrix-Vector Product
 - •Layer-wise Structure Learning for Fast DNN Training/Fine-Tuning
- Efficient and Robust Multi-modal Systems
 - •Probabilistic Models for Efficient and Robust Multi-modal DNN Training/Inference

PUBLICATIONS

Changwoo Lee and Hun-Seok Kim. *Differentiable Learning of Generalized Structured Matrices for Efficient Deep Neural Networks*, The Twelfth International Conference on Learning Representations (ICLR), 2024.

Fan, Z., Zhang, Q., Abillama, P., Shoouri, S., **Lee, C.**, Blaauw, D., Kim, H., and Sylvester, D. *TaskFusion: An Efficient Transfer Learning Architecture with Dual Delta Sparsity for Multi-Task Natural Language Processing*, In Proceedings of the 50th Annual International Symposium on Computer Architecture (ISCA), 2023.

Chenghong Bian, Chin-Wei Hsu, **Changwoo Lee**, and Hun-Seok Kim. *Learning-Based Near-Orthogonal Superposition Code for MIMO Short Message Transmission*, IEEE Transactions on Communications (TCOM), 2023

Changwoo Lee, Xiao Hu, and Hun-Seok Kim *Deep Joint Source-Channel Coding with Iterative Source Error Correction*, The 26th International Conference on Artificial Intelligence and Statistics (AISTATS), 2023

Fan, Z., An, H., Zhang, Q., Xu, B., Xu, L., Tseng, C., Peng, Y., Cao, A., Liu, B., **Lee, C.**, Wang, Z., Liu, F., Wang, G., Jiang, S., Kim, H., Blaauw, D., Sylvester, D. *Audio and Image Cross-Modal Intelligence via a 10TOPS/W 22nm SoC with Back-Propagation and Dynamic Power Gating*, IEEE Symposium on VLSI Circuits (VLSI-Symposium), 2022

Dong-Hee Kim, **Changwoo Lee**, and Ki-Seok Chung. *A Confidence-Calibrated MOBA Game Winner Predictor*, IEEE Conference on Games (CoG), 2020.

Changwoo Lee, and Ki-Seok Chung. *GRAM: Gradient Rescaling Attention Model for Data Uncertainty Estimation in Single Image Super Resolution*, IEEE International Conference on Machine Learning and Applications (ICMLA), 2019.

TALKS

SPEECS Seminar, on Structured Matrices. Ann Arbor, MI, USA. [link]

Mar 4 2024

SKILLS

Math. Matrix Decomposition, Linear Alghbra, Optimization Theory, Information Theory **Deep Learning.** DNN Compression, Weight/Activation Quantization, Transformers, Deep Generative Models, Diffusion Models.

Programming Languages and Frameworks. Python, PyTorch **Relevant Courses.**

- Umich EECS 501 Probability and Random Processes
- Umich EECS 551 Matrix Methods for Signal Processing, Data Analysis and Machine Learning
- Umich EECS 559 Optimization Methods in Signal Processing and Machine Learning
- Umich EECS 600 Function Space Methods in System Theory
- Umich EECS 598 Special Topics: Randomized Numerical Linear Algebra for Machine Learning
- Umich EECS 598 Special Topics: Statistical Learning Theory

ACADEMIC
EXPERIENCE

University of Michigan, Ann Arbor, Michigan, USA

PERIENCE Graduate Student Research Assistant

Aug 2020 - Present

TEACHING EXPERIENCE

TEACHING ASSISTANT

 Embedded System, Hanyang University 	Spring 2019
 VLSI Design, Hanyang University 	Fall 2018
 SoC Design, Hanyang University 	Spring 2018

AWARDS & SCHOLARSHIPS

 Hanyang University TA Scholarship 	Spring 2019
Hanyang Graduate School Scholarship (4 semesters)	2018-2019
Hanyang Brain Scholarship (2 semesters)	2017
 Undergraduate Scholarship, Korean Government, Korea Student Aid Foundation 	Fall 2016
Undergraduate Scholarship, Hanyang University (2 semesters)	2012-2013

SERVICE

Review Experience: IEEE Transactions on Communications, IEEE Transactions on Mobile Computing Student Volunteer at ICCV, 2019

Foreign Student Mentorship Program at Hanyang University, 2017

[CV compiled on 2024-03-21]